

Artificial Intelligence Development Platforms



## **Highlights**











- Up to 2 parallel Hailo-8<sup>™</sup> Al processors for massive processing performance up to 52 TOPS
- Full Hailo-8<sup>™</sup> performance combined with maximum power efficiency (FPS / W ratio) compared to other solutions from competition
- Up to 382 YOLOv5m / 2458 Resnet\_v1\_50 / 2080 Ssd\_mobilenet\_v1 object detection frames (416 x
   416) per second
- Comprehensive Hailo AI ecosystem incl. AI toolchain and developer tools
- Deep learning pre-trained models for various computer vision tasks to create fast prototypes on the Al platform





# **Product Description**

This AI platform enables industrial smart gateways with AI features for smart manufacturing, smart grids, industrial automation and more.



## Features

Features		
CPU		
Architecture:	Arm® Cortex®-A53	
Processor:	NXP® S32G274A CPU: 4 Arm® Cortex®-A53 64-bit cores, 3 Arm® Cortex®-M7 dual-cores	
DRAM:	4 GB 32-bit soldered LPDDR4 RAM at 1600MT/s	
Optional Power Supply Voltage:	Single DC power input (+6 V to +36 V)	
Extensions:	1x Hailo-8 <sup>™</sup> M.2 AI Acceleration Module (NGFF M.2 2242/2260/2280 Key M Card)	
Memory		
Flash:	64 MB QSPI Flash	
Flash Card:	Yes	
Boot Flash:	Boot select: XSPI, eMMC or external SD card	
eMMC:	16 GB	
Graphic		
HDMI Interface:	1x	
Camera Input:	2x MIPI-CSI camera interface connector, 2x 5 V/12 V supply	
Ethernet		
1GbE:	1x	
1000BASE-T1:	1x	
100 Mb:	1x	
100BASE-T1:	6x	
TSN / IEEE 1588:	Yes	
High Speed IO		
USB 2.0:	1x	
miniUSB:	1x	
Operating Condition		
Power Supply Voltage:	Single +12 V DC power input (+9 V to +15 V)	
RTC:	Yes	
RTC-Buffer:	Supercap	
Temperature:	0 °C to 70 °C	
Mechanical		
Dimensions:	200 mm x 140 mm	
Software / Additional		

www.microsys.de 2 | 5 - Linux
- VxWorks (on request)
- Others (on request)

Development Kit for immediate start up; includes power

supply, Linux pre-installed

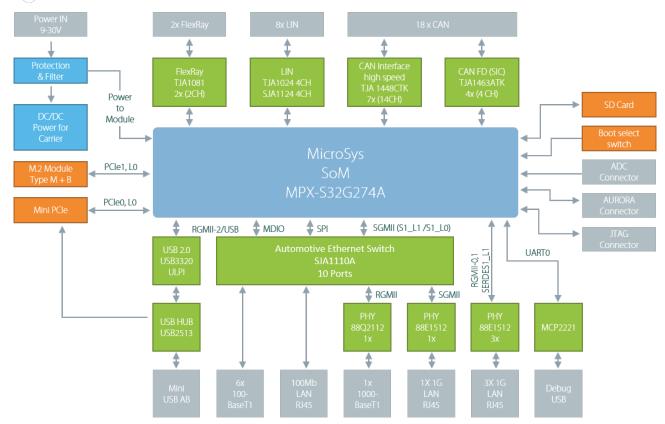
#### **General Note:**

Additional:

Our standard product versions offer what we consider to be the optimum configuration in terms of performance, price, usage and TDP. The product features lists specify the maximum range of functions per interface. However, not all interfaces or functions are always available in parallel. Flexible SERDES multiplexing is one of the reasons for this. In addition, we provide multiple memory expansion options and are also happy to accommodate specific customer wishes. So do not hesitate to <a href="contact us">contact us</a> directly to discuss your desired configuration.

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# **Block Diagrams**



miriac® AIP-S32G274A

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S32G274A + 1x Hailo-8™

Name Code **Description Status** AIP-S32G274A Development Kit 859013 4 Arm® Cortex®-A53, 1.0 GHz, 4 GB LPDDR4 w ECC, 64 MB NOR active Flash, 16 GB eMMC, 0 °C to 70 °C, SEC, 1x Hailo- $8^{TM}$ basic for miriac® MPX-



### **Related Products**

Name	Description	Image
miriac® SBC-S32G274A	NXP® S32G274A processor based SBCs for vehicle network computing	
miriac® MPX-S32G274A	Vehicle gateway platform with massive native CAN support	
miriac® MPX-S32G399A	MicroSys' 2nd Gen of System-on-Modules for vehicle networks based on the NXP® S32G399A processor	
miriac® AIP-S32G399A	High-performance embedded AI platforms	
miriac® SBC-S32G399A	NXP® S32G399A processor based SBCs for vehicle network computing	



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